

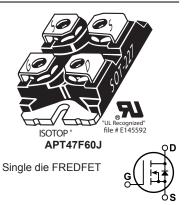


APT47F60J

600V, 49A, 0.09 Ω Max, t_{rr} \leq 310ns

N-Channel FREDFET

Power MOS 8TM is a high speed, high voltage N-channel switch-mode power MOSFET. A proprietary planar stripe design yields excellent reliability and manufacturability. Low switching loss is achieved with low input capacitance and ultra low C_{rss} "Miller" capacitance. The intrinsic gate resistance and capacitance of the poly-silicon gate structure help control slew rates during switching, resulting in low EMI and reliable paralleling, even when switching at very high frequency. Reliability in flyback, boost, forward, and other circuits is enhanced by the high avalanche energy capability.



FEATURES

- Fast switching with low EMI
- Low t_{rr} for high reliability
- Ultra low C_{rss} for improved noise immunity
- Low gate charge
- Avalanche energy rated
- RoHS compliant

TYPICAL APPLICATIONS

- ZVS phase shifted and other full bridge
- Half bridge
- PFC and other boost converter
- Buck converter
- · Single and two switch forward
- Flyback

Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
I_	Continuous Drain Current @ T _C = 25°C	49	
'D	Continuous Drain Current @ T _C = 100°C	31	A
I _{DM}	Pulsed Drain Current [®]	245	
V _{GS}	Gate-Source Voltage	±30	V
E _{AS}	Single Pulse Avalanche Energy [©]	1845	mJ
I _{AR}	Avalanche Current, Repetitive or Non-Repetitive	33	Α

Thermal and Mechanical Characteristics

Symbol	Characteristic	Min	Тур	Мах	Unit
P _D	Total Power Dissipation @ T _C = 25°C			540	W
R _{θJC}	Junction to Case Thermal Resistance Case to Sink Thermal Resistance, Flat, Greased Surface			0.23	°C/W
R _{ecs}			0.15		
T _J ,T _{STG}	Operating and Storage Junction Temperature Range			150	°C
V _{Isolation}	RMS Voltage (50-60hHz Sinusoidal Waveform from Terminals to Mounting Base for 1 Min.)	2500			V
W _T	Package Weight		1.03		ΟZ
I			29.2		g
Torque	Terminele and Mounting Corours			10	in∙lbf
loique	Terminals and Mounting Screws.			1.1	N∙m

Static Characteristics

$T_1 = 25^{\circ}C$ unless otherwise specified

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Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
V _{BR(DSS)}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_{D} = 250\mu A$		600			V
$\Delta V_{BR(DSS)} / \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	Reference to 25°C, $I_D = 250\mu A$			0.57		V/°C
R _{DS(on)}	Drain-Source On Resistance ^③	V_{GS} = 10V, I_{D} = 33A			0.075	0.09	Ω
V _{GS(th)}	Gate-Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 2.5 \text{mA}$		2.5	4	5	V
$\Delta V_{GS(th)} / \Delta T_J$	Threshold Voltage Temperature Coefficient				-10		mV/°C
	Zana Oata Maltana Duain Oursent	V _{DS} = 600V	T _J = 25°C			250	
DSS	Zero Gate Voltage Drain Current	$V_{GS} = 0V$	T _J = 125°C			1000	μA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =	= ±30V			±100	nA

Dynamic Characteristics

T_J = 25°C unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit	
9 _{fs}	Forward Transconductance	$V_{DS} = 50V, I_{D} = 33A$		65		S	
C _{iss}	Input Capacitance			13190			
C _{rss}	Reverse Transfer Capacitance	V _{GS} = 0V, V _{DS} = 25V f = 1MHz		135			
C _{oss}	Output Capacitance	1 111112		1210			
C _{o(cr)} ④	Effective Output Capacitance, Charge Related			645		pF	
C _{o(er)} (5	Effective Output Capacitance, Energy Related	V_{GS} = 0V, V_{DS} = 0V to 400V		335			
Q _g	Total Gate Charge			330			
Q _{gs}	Gate-Source Charge	$V_{GS} = 0$ to 10V, $I_{D} = 33A$,		70		nC	
Q _{gd}	Gate-Drain Charge	V _{DS} = 300V		140			
t _{d(on)}	Turn-On Delay Time	Resistive Switching		75			
t _r	Current Rise Time	V _{DD} = 400V, I _D = 33A		85		200	
t _{d(off)}	Turn-Off Delay Time	R _G = 2.2Ω [®] , V _{GG} = 15V		225		– ns	
t _f	Current Fall Time			70			

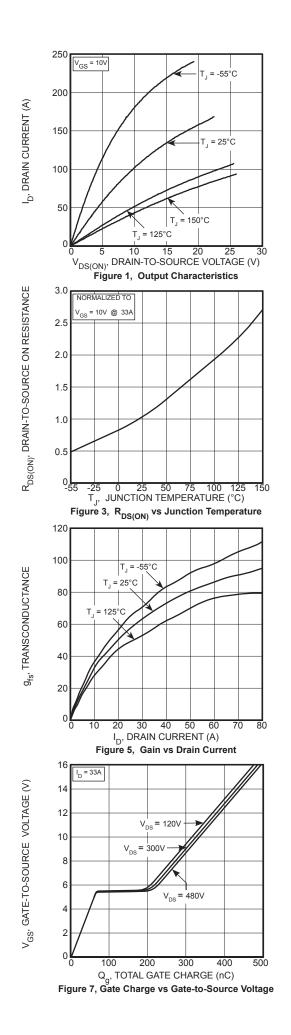
Source-Drain Diode Characteristics

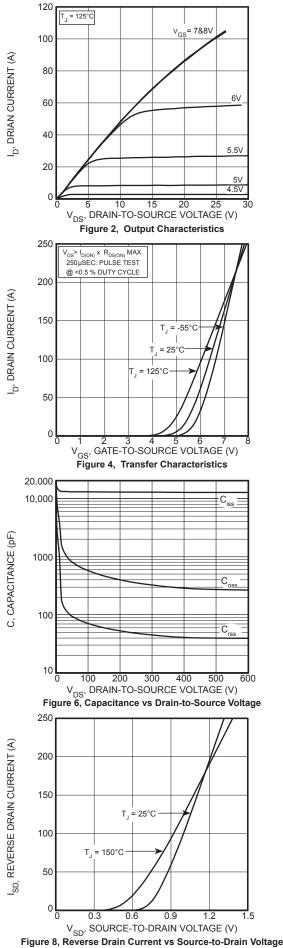
Symbol	Parameter	Test Conditions	Min	Тур	Мах	Unit
۱ _s	Continuous Source Current (Body Diode)	MOSFET symbol showing the	р \		49	А
I _{SM}	Pulsed Source Current (Body Diode) ^①	integral reverse p-n junction diode (body diode)	s		245	A
V _{SD}	Diode Forward Voltage	$I_{SD} = 33A, T_{J} = 25^{\circ}C, V_{GS} = 0V$			1.2	V
t _{rr}		T _J = 25°C		268	310	20
۲r	Reverse Recovery Time	T _J = 125°C		474	570	ns
Q _{rr}	Deveree Decevery Charge	$I_{SD} = 33A^{(3)}$ $T_J = 25^{\circ}C$		1.6		
C rr	Reverse Recovery Charge	$V_{DD} = 100V$ $T_{J} = 125^{\circ}C$		4.2		μC
	Devenue Devenue Orment	$di_{SD}/dt = 100A/\mu s$ $T_J = 25^{\circ}C$		11.4		
rrm	Reverse Recovery Current	T _J = 125°C		17		А
dv/dt	Peak Recovery dv/dt	I _{SD} ≤ 33A, di/dt ≤1000A/µs, V _{DD} = 400V, T _J = 125°C			20	V/ns

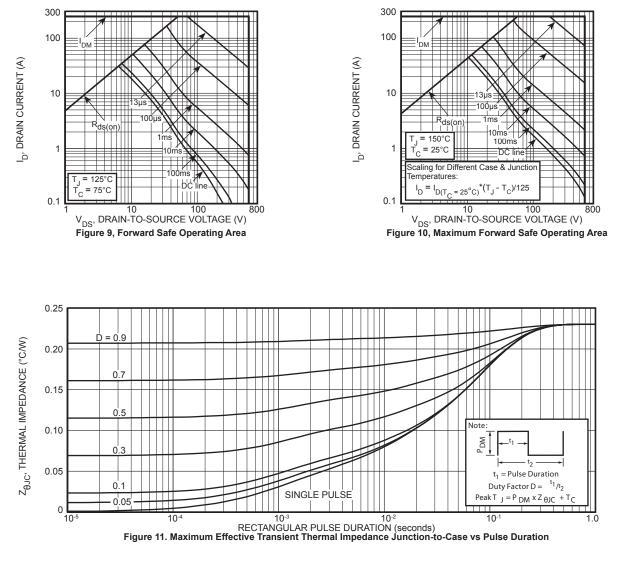
(1) Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

- (2) Starting at $T_1 = 25^{\circ}$ C, L = 3.39mH, $R_G = 25\Omega$, $I_{AS} = 33$ A.
- (3) Pulse test: Pulse Width < 380μ s, duty cycle < 2%.
- (4) $C_{o(cr)}$ is defined as a fixed capacitance with the same stored charge as C_{OSS} with $V_{DS} = 67\%$ of $V_{(BR)DSS}$. (5) $C_{o(er)}$ is defined as a fixed capacitance with the same stored energy as C_{OSS} with $V_{DS} = 67\%$ of $V_{(BR)DSS}$. To calculate $C_{o(er)}$ for any value of V_{DS} less than $V_{(BR)DSS}$, use this equation: $C_{o(er)} = -1.28E-7/V_{DS}^{2} + 5.36E-8/V_{DS} + 2.00E-10$.
- 6 R_G is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

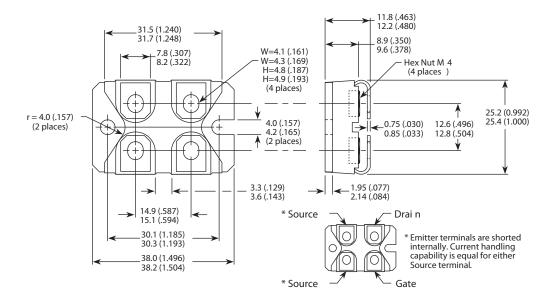
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SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

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<u>25.163.2453.0</u> <u>25.163.4253.0</u> <u>25.190.2053.0</u> <u>25.194.3453.0</u> <u>25.320.4853.1</u> <u>25.320.5253.1</u> <u>25.326.3253.1</u> <u>25.326.3553.1</u> <u>25.330.1653.1</u>
<u>25.330.4753.1</u> <u>25.330.5253.1</u> <u>25.334.3253.1</u> <u>25.334.3353.1</u> <u>25.350.2053.0</u> <u>25.352.4753.1</u> <u>25.522.3253.0</u> <u>T483C</u> <u>T484C</u> <u>T485F</u>
<u>T512F-YEB</u> <u>T513F</u> <u>T514F</u> <u>T554</u> <u>T612FSE</u> <u>25.161.3453.0</u> <u>25.179.2253.0</u> <u>25.194.3253.0</u> <u>25.325.1253.1</u> <u>25.326.4253.1</u> <u>25.330.0953.1</u>
<u>25.332.4353.1</u> <u>25.350.1653.0</u> <u>25.350.2453.0</u> <u>25.352.1453.0</u> <u>25.352.1653.0</u> <u>25.352.2453.0</u> <u>25.352.5453.1</u> <u>25.522.3353.0</u> <u>25.602.4053.0</u>
25.640.5053.0